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<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> <i>( Not for submission under 37 CFR 1.99)</i>	Application Number		10762916
	Filing Date		2004-01-22
	First Named Inventor		Daniel M. DIAS
	Art Unit		2154
	Examiner Name		Jeong S. PARK
	Attorney Docket Number		SVL920030091US1/4181P

U.S.PATENTS						
Examiner Initial*	Cite No	Patent Number	Kind Code <sup>1</sup>	Issue Date	Name of Patentee or Applicant of cited Document	Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear
	1	6058102		2000-05-02	Drysdale et al.	
	2	6366563		2002-04-02	Weldon et al.	
	3	6597956		2003-07-22	Aziz et al.	

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	1	20010027484	A1	2001-10-04	Nishi	
	2	20010047411	A1	2001-11-29	Kurose et al.	
	3	20020107743	A1	2002-08-08	Sagawa	

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4	20020198995	A1	2002-12-26	Liu et al.	
5	20030009580	A1	2003-01-09	Chen et al.	
6	20030074347	A1	2003-04-17	Phillips	
7	20030058797	A1	2003-03-27	Izmailov et al.	
8	20030093537	A1	2003-05-15	Tremlett et al.	
9	20050188075		2005-08-25	Dias et al.	
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	1	S.D. Antonio et al., A Component-Based Approach to SLA Monitoring in Premium IP Networks, available at <a href="http://216.239.53.104/search?q=cache:b6PUisFh7rEJ:www.ist-intermon.org/workshop/papers/07_02_sla_monitoring_final.pdf+A+Component-based+Approach+to+SLA+Monitoring+in+Premium+IP+Networks&amp;hl=en&amp;ie=UTF-8">http://216.239.53.104/search?q=cache:b6PUisFh7rEJ:www.ist-intermon.org/workshop/papers/07_02_sla_monitoring_final.pdf+A+Component-based+Approach+to+SLA+Monitoring+in+Premium+IP+Networks&amp;hl=en&amp;ie=UTF-8</a> , on January 21, 2004	<input type="checkbox"/>
	2	Preeti Bhoj et al., SLA Management in Federated Environments, December 1998.	<input type="checkbox"/>

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